

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

TIG058E8 — N-Channel IGBT

Light-Controlling Flash Applications

Features

- · Low-saturation voltage
- · Enhansment type
- Mounting Height 0.9mm, Mounting Area 8.12mm²
- · Halogen free compliance

- · Low voltage drive (4V)
- · Built-in Gate-to-Emitter protection diode
- dv / dt guarantee*

Specifications

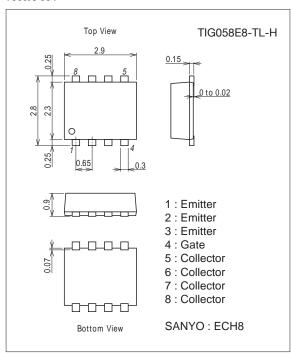
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Emitter Voltage	VCES		400	٧
Gate-to-Emitter Voltage (DC)	VGES		±6	V
Gate-to-Emitter Voltage (Pulse)	VGES	PW≤1ms	±8	V
Collector Current (Pulse)	ICP	C _M =150μF, V _{GE} =4V	150	Α
Maximum Collector-to-Emitter dv / dt	dVCE / dt	V _{CE} ≤320V, starting Tch=25°C	400	V/μs
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-40 to +150	°C

*: Concerning dv / dt (slope of Collector Voltage at the time of Turn-OFF), dv / dt > 400V / µs will be 100% screen-detected in the circuit shown as Fig. 1.

Package Dimensions

unit: mm (typ) 7011A-004

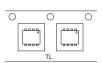


Product & Package Information

• Package : ECH8 • JEITA, JEDEC : -

• Minimum Packing Quantity : 3000 pcs./reel

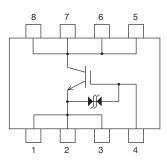
Packing Type: TL



Marking



Electrical Connection



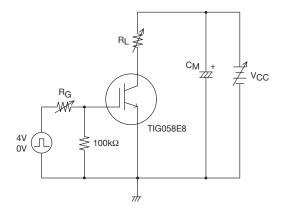
SANYO Semiconductor Co., Ltd.

http://semicon.sanyo.com/en/network

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit	
Farameter	Symbol		min	typ	max	Uill	
Collector-to-Emitter Breakdown Voltage	V(BR)CES	IC=2mA, VGE=0V	400			V	
Collector-to-Emitter Cutoff Current	ICES	V _{CE} =320V, V _{GE} =0V			10	μΑ	
Gate-to-Emitter Leakage Current	IGES	VGE=±6V, VCE=0V			±10	μΑ	
Gate-to-Emitter Threshold Voltage	VGE(off)	V _{CE} =10V, I _C =1mA	0.4		0.9	V	
Collector-to-Emitter Saturation Voltage	V _{CE} (sat)	I _C =100A, V _{GE} =4V		4.0	5.6	V	
Input Capacitance	Cies			2200		pF	
Output Capacitance	Coes	V _{CE} =10V, f=1MHz		32		pF	
Reverse Transfer Capacitance	Cres			24		pF	

Fig.1 Large Current R Load Switching Circuit

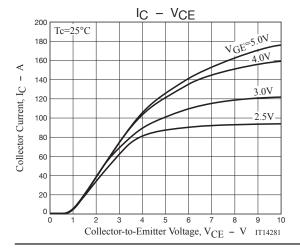


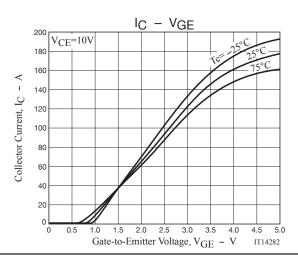
Note1. Gate Series Resistance $R_G \ge 230\Omega$ is recommended for protection purpose at the time of turn OFF. However, if $dv / dt \le 400V / \mu s$ is satisfied at customer's actual set evaluation, $R_G < 230\Omega$ can also be used.

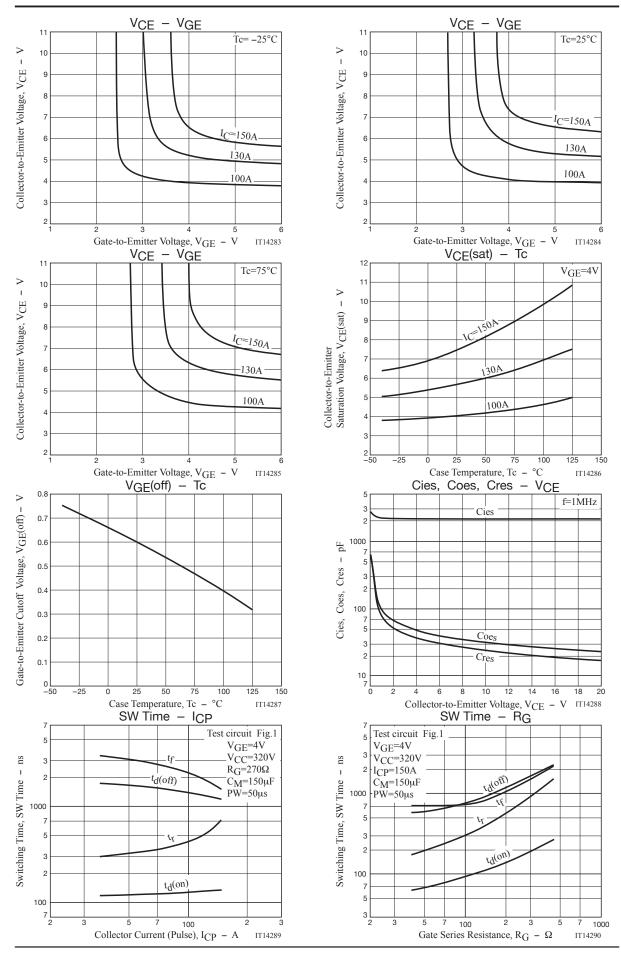
Note2. The collector voltage gradient dv / dt must be smaller than 400V / μs to protect the device when it is turned off.

Ordering Information

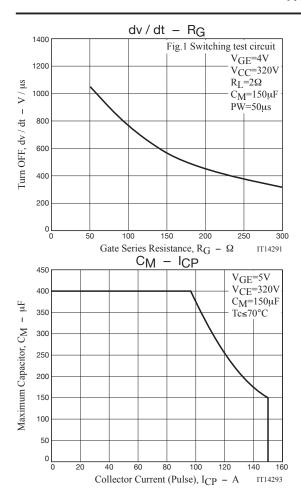
Device	Package	Shipping	memo
TIG058E8-TL-H	ECH8	3.000pcs./reel	Pb Free and Halogen Free

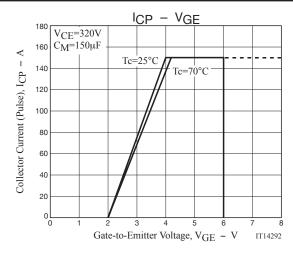






TIG058E8



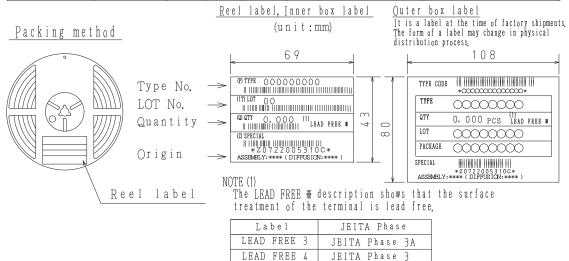


Embossed Taping Specification

TIG058E8-TL-H

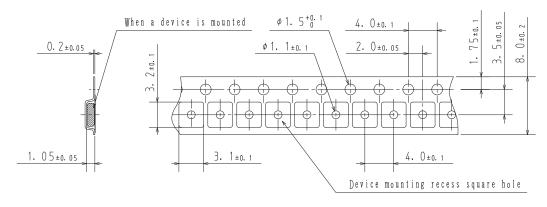
1. Packing Format

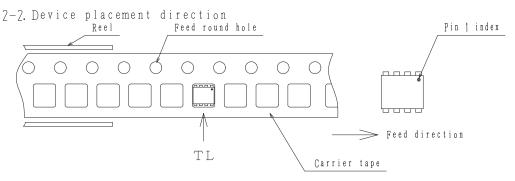
Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing format		
	Туре	Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)	
ECH8	СРН6	3, 000	15, 000	90,000	5 reels contained	6 inner boxes contained	
					Dimensions:mm (external)	Dimensions:mm (external)	
					183×72×185	440×195×210	



2. Taping configuration

7-1. Carrier tape size (unit:mm)

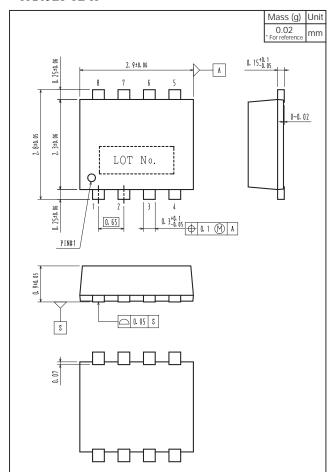




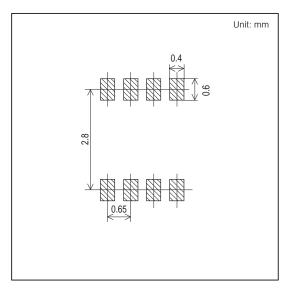
Those with pin 1 index on the feed hole side · · · · · TL

Outline Drawing

TIG05E8-TL-H



Land Pattern Example



Note: TIG058E8 has protection diode between gate and emitter but handling it requires sufficient care to be taken.

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